

2016

IEC 61439

Die neue Norm für Niederspannungs-Schaltgerätekombinationen

IEC 61439 = EN 61439 = VDE 0660-600



Foreword / introduction

This document is designed to assist you and enables us to secure our common success.

This workbook contains general information and proposals for designing, planning and building low voltage switchgear and controlgear ASSEMBLIES in compliance with the applicable laws, directives and provisions.

Basic knowledge in electrical engineering is essential for planning low voltage switchgear and controlgear ASSEMBLIES.

This workbook includes general and special information which is essential for safe, reliable and economical low voltage switchgear and controlgear ASSEMBLY operation.

In addition, the topics designed to protect people and assets are being dealt with.

Distribution boards in the low voltage network

Distribution boards serve as link between electrical appliances and users. They form the visible part of an electrical system and represent the electrical company having installed the ASSEMBLY.

The requirements in terms of flexibility and safety for distribution boards are particularly high:

- Personal protection
- Property protection
- High operational and functional safety
- Ease of use

Solid design to prevent unprofitable investment:

- Optimum adaptability to use cases
- Cooperation between user / planner / manufacturer to balance specifications and costs

Why a new standard? Who is the manufacturer?

Health of the individual is regarded as fundamental asset within the economic space of the European Union.

The EU-Commission has therefore made it its goal to elaborate directives, which are then transposed into national law by Member States.

Thus, the low voltage directive is implemented in the German Product Safety Act.

Next to the German Product Safety Act, there is the Product Liability Act which is designed to protect the user in case of damages.

Both laws pursue safety targets and are designed to protect people, livestock and property.

Regarding product liability for example, injured parties will only have to demonstrate that their legal rights have been violated and that this violation led to a loss and that the manufacturer has introduced a defective product to the market and that there is causality between the defective product, the violation of legal rights and the damage.

The question whether a manufacturer is responsible for product defects puts an unacceptable burden of proof on the injured party.

This is the reason why a reversed burden of proof is applied here. Meaning that the manufacturer has to prove that the product was free from defects in design, workmanship and instructions upon marketing.

The new standard precisely defines the responsibilities for a marketed product. It differentiates between original manufacturer and ASSEMBLY manufacturer.



How can the original manufacturer or the manufacturer verify the safety of an ASSEMBLY?

The new standard describes three design verification processes for ASSEMBLIES and requires a routine verification for every marketed product.

Testing	Calculation / measurement	Application of constructive rules		
 such as electrical mechanical thermal tests in accordance	 such as Calculating of temperature rises	 such as specified dimensions test steps ASSEMBLY sequences		
with the requirements specified	or of short-circuit forces Measurement of clearances and	based on tested reference		
in the standard	creepage distances	designs		

These processes are essentially implemented by the original manufacturer. In case that the ASSEMBLY manufacturer does not install an ASSEMBLY in compliance with the instructions of the original manufacturer, the ASSEMBLY manufacturer will become original manufacturer for that alteration and will have to carry out the design verification in accordance with the described procedures.



The ASSEMBLY manufacturer always has to implement the routine verification.

How can a low-voltage switchgear and controlgear ASSEMBLY be realized safely?

The new standard does not only precisely define the responsibilities of the market participants, but also specifies the dimensions of low-voltage switchgear and controlgear ASSEMBLIES.

In addition it presents the possibilities and limits for the market participants in order to guarantee to the user safe low-voltage switchgear and controlgear ASSEMBLIES.

It is also designed to specify the documentation required for

low-voltage switchgear and controlgear ASSEMBLIES and/or the required verifications.

Which are the dimensioning specifications enabling design verification?

One important aspect emphasised in the IEC 61439 is the earthing system as this has important consequences for planing the electrical circuits.

Collecting the requisite data Connection to the electrical system

How are ASSEMBLIES dimensioned?

ASSEMBLIES are dimensioned through the definition of interface values.



1) Connection to the electrical system	2) Electrical cicuits and loads
 Nominal voltage of the incoming supply Electrical system Rated current Short-circuit withstand strength Overvoltage Connecting cable 	 Distribution circuits for load-side subdistribution panels Final circuits
 3) Installation and environmental conditions Indoor installations Outdoor installations Dimensions for transport and installation 	 4) Operating and servicing Operation through: Device activation Access control

Connection to the electrical system Check list

(1) Connection to the electrical system

Characteristics	Information provided by the planner / customer	Information provided by the manufacturer
Nominal voltage of the incoming supply	AC V Hz	U _e = V
	DC V	f _n = Hz
System	TN-C	Protection by
	TN-C-S	automatic disconnection of the
	TN-S	power supply (PC I)
	Π	
	IT	protection by protective insulation (PC II)
Rated current	Supply current (nominal current transformer /	I.= A
	upstream protective device)	
Short-circuit withstand strength	l = kA	I. = kA
(please see notes on pages 73 - 77)	(uninfluenced short-circuit current at the supply terminals)	$I_{\mu\nu} = kA$
		KA
Overvoltage	Overvoltage category	Rated impulse withstand voltage
	III	U _{imp} = kV
	IV	
Incoming line connection	from below	single-core cable
	from above	multi-core cable
	copper conductor	number
	aluminium conductor	mm ² section
	Connection using terminal blocks	copper conductor
		aluminium conductor
		connection to equipment
		connection using terminal blocks

Electrical circuits and loads Check list

2 Circuits and consumers

Consumer / circuit	Information provided by the	planner / customer	Data to be derived from step 2 by manufacturer		
types	Number of circuits	Type of protective device	Distribution board ratings	Circuit ratings	Type of protective device
				Rated Diversity Factor (RDF) =%	
Distribution circuits for downstream subdistribution boards		fuse MCB MCCB			
Final circuits					
	Number of circuits	Type of the protective conduc- tor connection	Consumer ratings	Circuit ratings	Type of protective device
Socket		fuse MCB Circuit breaker and residual current device	A	I _{nc} = A	
Ohmic load, heater		fuse MCB MCCB	kW	I _{nc} = A	
Inductive consumer, motor, direct		fuse MCB MCCB	KW cos <i>\$</i>	I _{nc} = A	
Inductive consumer, motor, controlled		Inse MCB manufacturer's description	kW cos <i>q</i>	I _{nc} = A	

Installation and environmental conditions Check list

(3) Installation and ambient conditions of ASSEMBLIES

Conditions of use	Information provided by the	Measures/recommendations of the AS	SEMBLY manufacturer	Selection		
	planner / customer Definition pursuant to standard IEC 61439-1 This information is to be taken into account in the planning of ASSEMBLIES					
Indoor installation	Atmospheric conditions Foreign bodies / dust	not less than IP2X	Comply with more severe requirements arising from the product standard			
	Foreign bodies	Diameter ≥ 12.5 mm	IP2X			
	Foreign bodies	Diameter ≥ 2.5 mm	IP3X			
	Dust Increased presence of dust	dust-protected	IP5X			
	Dust conductible	dusttight	IP6X			
	Humidity / water					
	Dripping water		IPX1			
	Occasional cleaning around the distribution board, impact by diverted water		IPX4			
	Functional cleaning around the distribution board, impact by diverted water		IPX5			
	Temporary immersion		IPX7			
	Room air conditioned / tempera- ture range	-5 to +35 °C	Indicate the power loss of the ASSEMBLY for the dimensioning of the air-conditioning			
	Room ventilated / temperature range, relative humidity	-5 to +35 °C 90 % at 20 °C, up to 50 % at 40 °C	Indicate the power loss of the ASSEMBLY for ventilation dimensioning; and state the room size. Higher ambient air temperatures are to be taken into account in the planning of ASSEMBLIES			
Outdoor installation	Protected installation / temperature range, relative humidity (against rain, sunshine and wind)	-25 to +35 °C 90 % at 20 °C, up to 50 % at 40 °C, short term up to 100 % at 25 °C	Possible measures against moderate condensation due to temperature variations: Ventilating, heating, air conditioning			
	Foreign bodies / dust	not less than IP2X	For increased dust production use a higher degree of protection such as IP5X			
	Humidity / water	not less than IPX1	The manufacturer states the suitability of the protected installation, if necessary by applying additional measures			
	Unprotected installation / temperature range rel. humidity	-25 to +35 °C 90 % at 20 °C, up to 50 % at 40 °C, short term up to 100 % at 25 °C	Higher ambient air temperatures which might result from direct sunlight are to be taken into account in the planning of ASSEMBLIES Possible measures against moderate condensation due to temperature variations: Ventilating, heating, air conditioning			
	Direct sunlight	UV resistance	Follow manufacturer's instructions			
	Foreign bodies / dust	not less than IP2X	For increased dust production use a higher degree of protection such as IP5X			
	Humidity / water	not less than IPX1	The manufacturer states the suitability of the protected installation, if necessary by applying additional measures			

Installation and environmental conditions Check list

(3) Installation and ambient conditions of ASSEMBLIES

			1	
Conditions of use	Information provided by the	Measures/recommendations of the ASS	Selection	
		Definition pursuant to standard IEC 61439-1	This information is to be taken into account in the planning of ASSEMBLIES	
Dimensions for transport and installation	Type of installation: To the wall (recess), to the wall, free installation to base frame, double floor	None		
	Aisle widths / escape routes: Room dimensions and access doors	See IEC 60364-7-729 Requirements for special installations or locations – operating or maintenance gangways	Minimum aisle widths and the direction of the escape routes are to be taken into account in the planning of ASSEMBLIES	
	Distribution board: max. dimensions: W x H x D max. weight	None	Possible restrictions are to be stated	W H D kg
	Transport: max. transport dimen- sions W x H x D, max. transport weight Transport type, e.g. crane Accessibility at the construction site	None	Possible restrictions are to be stated, such as only standing transport, max. acceleration values	W H D kg
Chemical influences		None	Type of the enclosure material Chemical device version Special installation / ventilation	
Mechanical impact		Sub-distribution board Indoor installation Outdoor installation		IK05 IK07
Enclosure material	Sheet steel Plastic	None		
Enclosure colour			Comply with customer specifications / tender documents	
EMC	Environment A Non-public or industrial LV networks / areas / installations including strong sources of interference		Confirmation by the manufacturer in accordance with environment A	
	Environment B Public LV networks such as domestic, commercial and light industrial locations		Confirmation by the manufacturer in accordance with environment B	

Operating and servicing Check list

4 Operating and servicing

Characteristics	Information provided by the planner / customer	Information provided by the manufacturer	Selection
Operation through:	Skilled person (electrically) Instructed person Ordinary persons	IPXXB IPXXB IPXXC	
Device activation	Behind the door / cover From outside		
Access / door closure	Lock For semi-cylinder (central locking system) Other		

Accompanying standards: EN 50110-1 Operation of electrical installations – general requirements EN 50110-2 Operation of electrical installations / national annexes

IEC 60050 International electrotechnical vocabulary

Distribution board design and design verification

How can the original manufacturer or the manufacturer verify the safety of an ASSEMBLY?

The new standard describes three design verification processes for an ASSEMBLY and requires a routine verification for each marketed product

Testing	Calculation / measurement	Application of constructive rules
such as – electrical – mechanical – thermal tests in accordance with the requirements stated in the standard	 such as Calculating of temperature rises or of short-circuit forces Measurement of clearances and of creepage distances 	such as – specified dimensions – test steps – ASSEMBLY orders, based on tested reference constructions

These processes are essentially implemented by the original manufacturer. In case that the ASSEMBLY manufacturer does not install an ASSEMBLY in compliance with the instructions of the original manufacturer, the ASSEMBLY manufacturer will become original manufacturer for that alteration and will have to carry out the design verification in accordance with the described procedures.

Distribution board design and design verification Verification of the short-circuit withstand strength

10.11 Verification of the Short-circuit withstand strength:

We have carried out numerous Short-circuit tests for our low voltage switchgear and controlgear ASSEMBLIES and for our system components, which we can use for the creation of our design verifications. In this section we will specify some general terms for you and give you some information to assist you in your daily selection of corresponding components.

The peak short-circuit current I_p is used to assess mechanical strength. The thermal effects of the short-circuit current can be assessed using the effective value I_{p} .



I_p = Peak short-circuit current

I ____ = Uninfluenced short-circuit current (effective value)

System	Limit*	Installation
l _p	\leq 17 kA \leq	l pk
I _{cp (eff)}	≤ 10 kA ≤	I cw (eff)
l _{cp (eff)}	\leq 10 kA \leq	Cc (eff)

 I_{pk} = Rated peak withstand current (strength of the ASSEMBLY against electro-dynamic forces; manufacturer information)

I_{cw} = Rated short-time withstand strength (strength of the ASSEMBLY against the heat effect of the current (effective value); manufacturer information)

 I_{cc} = conditional rated short-circuit current (strength of the ASSEMBLY against heat effects and the electro-dynamic forces of the current defined in length and importance by a Short-circuit protective device (effective value); manufacturer information)

A verification of the Short-circuit withstand strength is not required if the short-circuit current at the supply position is below the limits!

*Assumed to section 10.11.2 IEC 61439-1

Distribution board design and design verification Short circuit – key terms^{*1}



- $i_{(t)}$ = course of the alternating current over the time t
- i_{o} = peak value (instantaneous value) of the alternating current
- $i_p^{(i)}$ = peak value (instant i_D = short-time current
- $i_{D eff}$ = effective value of the short-time current
- i_n = nominal value of the alternating current

Ratio between surge current and short-time current*2

For approximate calculation purposes: $I_p = I_{D eff} x n$

*1 See also EN 60909-0 *2 See also section 9.3.3 IEC 61439-1 and table 7

Distribution board design and design verification Verification of the short-circuit withstand strength

The short-circuit protective device may be installed inside or outside the low voltage switchgear and controlgear ASSEMBLY:



In this case it must be made sure that the short-circuit current $I_{\rm p}$ and the uninfluenced short-circuit current $I_{\rm cp}$ at the connection point are smaller and/or equal to the values specified by the manufacturer:

$$|_{p} \leq |_{pk}$$

 $|_{cp} \leq |_{cw}$

If not duration is indicated for ${\rm I}_{\rm \scriptscriptstyle cw}$ a test length t of 1 sec. is to be used.

Distribution board design and design verification Verification of the short-circuit withstand strength

If the ASSEMBLY manufacturer specifies the conditional rated short-circuit current for the connection point (I_{cc}) also the breaking capacity and the current limitation characteristic ($I^{2}t$, I_{pk}) of the specified, upstream Short-circuit protective device (taking into account the data submitted by the device manufacturer) are to be stated.

For simplification reasons, also the type and name of the device manufacturer (and of the fuse inserts, if necessary) should be inserted here.

A verification of the short-circuit withstand strength is not required for:

- ASSEMBLIES with a rated short-time withstand current (I_{pk}) or rated conditional short-circuit current (I_{cc}) not exceeding 10 kA effective value.
- ASSEMBLIES or circuits of ASSEMBLIES protected by current-limiting devices having a cut-off current not exceeding 17 kA at the maximum allowable prospective short-circuit current at the terminals of the incoming circuit of the ASSEMBLY.
- Auxiliary circuits of ASSEMBLIES intended to be connected to transformers whose rated power does not exceed 10 kVA for a rated secondary voltage of not less than 110 V, or 1.6 kVA for a rated secondary voltage less than 110 V, and whose short-circuit impedance is not less than 4%. All other circuits are to be verified.

(for a text excerpt see DIN EN 61439-1 (VDE 0660-600) 10.11.2)

Example: Limiting the short-circuit current and the cut-off current I_D and cut-of energy I^2t by fuses.



Distribution board design and design verification Transformer nominal values table

For many cases it may be assumed that the short-circuit current will not exceed the limits* specified.

Transformer nominal values									
Nominal voltag	le								
U _N	230/400 V			525V			400/690 V		
Short-circuit voltage									
U _K		4 %	6 %		4 %	6 %		4 %	6 %
Nominal	Nominal	Short-circuit cu	urrent I _k	Nominal cur-	Short-circuit cu	urrent I _k	Nominal cur-	Short-circuit cu	urrent I _k
rating $S_{\rm N}$	current $I_{\rm N}$			rent $I_{\rm N}$			rent I _N		
[kVA]	[A]	[A]	[A]	[A]	[A]	[A]	[A]	[A]	[A]
50	72	1805	-	55	1375	-	42	1042	-
100	144	3610	2406	110	2750	1833	84	2084	1302
160	230	5776	3850	176	4400	2933	133	3325	2230
200	280	7220	4860	220	5500	3667	168	4168	2784
250	360	9025	6015	275	6875	4580	210	5220	3560
315	455	11375	7583	346	8660	5775	263	6650	4380
400	578	14450	9630	440	11000	7333	336	8336	5568
500	722	18050	12030	550	13750	9166	420	10440	7120
630	910	22750	15166	693	17320	11550	526	13300	8760
800	1156	-	19260	880	-	14666	672	-	11336
1000	1444	-	24060	1100	-	18333	840	-	13920
1250	1805	-	30080	1375	-	22916	1050	-	17480
1600	2312	-	38530	1760	-	29333	1330	-	22300
2000	2888	-	48120	2200	-	36666	1680	-	27840
2500	3616	-	60210	2750	-	45833	2090	-	34830
3150	4546	-	75770	3464	-	57730	2635	-	43930

Rated currents and short-circuit current of standard transformers

 S_{N} [kVA] = Apparent power of the transformer

- $U_{N}[V]$ = Nominal voltage of the transformer
- I_N [A] = Nominal current of the transformer
- = Short-circuit voltage of the transformer U_κ [%]
- Ι_κ [A] = Short-circuit current of the transformer

 $I_{N} = S_{N} / (\sqrt{3} U_{N})$ $I_{K} = (I_{N} / U_{N} [\%]) \times 100$

* See chapter 2, section 10.11

Verification of the short - circuit strength

10.10 Verification of temperature rise

Next to the option to verify temperature rises inside lowvoltage switchgear and controlgear ASSEMBLIES using a test, DIN EN 61439-1 describes two calculation methods which may also be used:

Verification of temperature rise up to 630 A

 Comparison between the installed power loss and the power loss that can be dissipated in the range up to 630 A (only possible if there are no horizontal partitions)

For the verification, see page 69

Temperature rise verification up to 1600A

 Verification that temperature rise limits are not exceeded in the distribution board, this applies to the range up to 1600 A (according to DIN EN TR 60890)

For the verification, see page 85

Temperature rise verification up to 1600 A

 Temperature rise verifications above 1600 A are to be made by testing

10.10 Verification of temperature rise

Next to the option to verify temperature rises inside low voltage switchgear and controlgear AS-SEMBLIES using a test, IEC 61439-1 describes two calculation methods which may also be used:

- Comparison between the installed power loss and the power loss that can be dissipated in the power range up to 630 A (only possible if there are no horizontal partitions)
- Verification that temperature rise limits are not exceeded in the distribution board, this applies to the power range up to 1600 A (according to IEC TR 60890)

Verification of temperature rise up to 630 A

Temperature rises up to 630 A may be verified under the assumption that the heat loss of all equipment and electrical conductors is evenly distributed across the enclosure. For this method the standard demands that no internal form separation restricts the heat flow.

Since the actual distribution of the heat sources in enclosures does not necessarily comply with the above-stated ideal conditions, the standard requires for calculated verification methods (up to 630 A) the application of a reduction factor (derating factor).

There are two different starting conditions: a) the operating currents (load currents) are known or b) the rated current is specified by the preselection of equipment.

Example I

The operating currents are known and the rated current for the incoming supply is to be determined from the sum of the outgoing operating currents:

3 outgoing circuits having an operating current of $I_{B} = 150 \text{ A}$

$$I_{B} = \frac{\sum I_{B \text{ outgoing circuits}}}{n^{*}} = \frac{450 \text{ A}}{0.9} = 500 \text{ A}$$

with an assumed load factor n = 0.9 taken from table 101, EN 61439-2 (Attention: Part 3 provides for another reduction of the load factors)

$$I_{nA} = \frac{I_B}{0.8^{**}} = \frac{500 \text{ A}}{0.8} = 625 \text{ A}$$

As incoming equipment a fuse switch disconnector size III (630 A) would have to be selected, for example.

*With an assumed load factor of n = 0,9 taken from table 101 of IEC 61439-2 (Attention part 3 provides for an other reduction of the load factors)

**Assumed load factor pursuant to section 10.10.4.2.1 of part 2 of the standard

Example II

The operating current of the outgoing circuit is defined by the equipment selection so that the rated current of the outgoing circuit is calculated as follows:

Disconnector size 00, 160 A

 $I_{nc} = I_{R} \cdot 0.8^{*} = 160 \text{ A} \cdot 0.8 = 128 \text{ A}$

Reducing the rated current of each circuit leads also to another reduction of the power loss to be taken into account regarding the power losses occurring with the rated current.

Example III

 I_{th} = 160 A at ambient air temperature, power loss of the equipment P_{vth}=30 W

 $I_{nc} = I_{B} \cdot 0.8 = 160 \text{ A} \cdot 0.8 = 128 \text{ A}$

$$\frac{P}{P_{Vth}} = \left(\frac{I}{I_n}\right)^2; \ \frac{P}{30} = \left(\frac{128}{160}\right)^2; \ P = 19,2W$$

Verified ASSEMBLIES are to be calculated so that the wiring sections are to be designed in accordance with the current rating of the associated circuit and all sections shall have not less than 1.25 times (125 %) of the current rating.

Example IV

I_{th}=160 A at ambient air temperature

 $I_{nc} = I_{B} \cdot 0.8 = 160 \text{ A} \cdot 0.8 = 128 \text{ A}$

with a derating factor of 0.8 to be taken into account for the calculation up to 630 A.

 $I_{nc'} \cdot 1.25 = 160 \text{ A}$

Single-core cables, touching free in air in accordance with Table H.1, Anne H, IEC 61439-1

I_{nc} = 160 A Cross-sectional area of conductor: 70 mm² (max. operating current 171 A)

*Assumed load factor pursuant to section 10.10.4.2.1 of part 2 of the standard

Verification of temperature rise up to 630A

The following table may be used for a simplified calculation up to 630A:

					Rated current of the equipment I _n	P _{vn}	Derating ¹⁾	Rated current of a circuit I_{nc}	Assumed load factor ²⁾	Assumed operating current I _B	Power loss of a device at I _B	Sum of the power losses
		Inner		E	(A)	(W)		(A)		(A)	(W)	(W)
Position	Number	Manufaci	Type	Descriptio						$I_{B} = I_{nc} \cdot$ assumed load factor	$\begin{split} \boldsymbol{P}_{_{B}} &= \boldsymbol{P}_{_{VN}} \cdot \\ (\boldsymbol{I}_{_{B}}/\boldsymbol{I}_{_{N}})^2 \end{split}$	$P_{_{VB}} = P_{_{B}} \cdot$ number
Sum of the installed power losses												
Wiring power loss (%) ³⁾ 30												
Power loss dissipation of the enclosure												
Difference = power loss dissipation - sum of the installed power loss = $P_{vai} - \sum P_{vB}$												

1) According to IEC 61439-2 Table 101 – Values of assumed loading – depending on the number of equipment used in the same time 2) Manufacturer information for equipment under different conditions, but not less than 0.8 in line with section 10.10.4.2.1c

3) The wiring power loss is assumed as percentage of the equipment power losses – proposal: 30 %

If there is a positive difference between the dissipated power losses and the sum of the installed power losses, the temperature rise of the low voltage switchgear and controlgear ASSEMBLY is verified! In which case the ASSEMBLY manufacturer may indicate a RDF of 100 % for the complete installation since sufficient design reserves have been taken into account.

If there is a negative difference between dissipated power losses and installed power losses, further action is required in the field:

- Ventilation of the enclosure
- Selecting a larger enclosure

Or, as a third option, the manufacturer may also reduce the rated diversity factor:

– Determining of a smaller RDF (\leq 80 %)

The RDF is the percent value of the rated current which the ASSEMBLY may carry continuously and simultaneously taking into account the mutual thermal influences.

$$RDF = \sqrt[2]{\frac{\text{dissipated power loss}}{\text{installed power loss}}} *100 \ [\%]$$

It may be specified by the ASSEMBLY manufacturer for the entire low voltage switchgear and controlgear ASSEMBLY combination or for groups of outgoing circuits.

You will find the necessary information on the installed power losses for our enclosures in the technical specifications of our catalogues and in our design software.

Verification of temperature rise up to 1600A

For temperature rise verifications it is also possible to use a method to calculate the temperature rise limits according to IEC 61439. This method (in accordance with IEC TR 60890) is implemented in our Panel Design Configurator software.



Building / manufacture of the distribution board

	Constructional requirements	Section from IEC 61439-2, 3
3.1	ASSEMBLY of individual components / groups of components to enclosures / cabinets - Please observe the information in our catalogues / ASSEMBLY instructions - Observing the protective measures for switchgear in - Protection class I (with protective conductor) - Protection class II (double insulation)	8.4.3.2 8.4.4
3.2	Installation of the devices – The devices must be installed according to our instructions and/or the instructions of the device manufacturer – Care should be taken in particular to ensure: – the accessibility of the devices – sufficient heat dissipation / ventilation – For installation distribution boards the protective devices must be suited for an operation by ordinary people	8.5 8.5.4 8.5.5 8.7 8.5.3
3.3	Wiring inside switchgear - General requirements for the wiring of bare and insulated conductors - Selecting the cross-sections - Recommendation of the cross-sections depending on the load capacities and types of installation - Selecting the cross-sections of N, PE and PEN conductors - Cross-section of N conductors - Up to 16 mm² including, 100 % of the associated phase conductors - Above 16 mm², 50 % of the associated phase conductors, not less than 16 mm² - Cross-section of PEN conductors - PEN min. 10 mm² for CU and 16 mm² for Al, not smaller than the neutral conductor It is assumed that the neutral conductor will not exceed 50 % of the phase conductor currents. Due to the usual operating conditions (e.g. harmonics, non-synchronous loads due to AC consumers) the N, PEN conductor should correspond to the cross section of PE conductors. - Cross-section of PE conductors - Earthed and short-circuit protected installation - Wire markings of insulated conductors in main and auxiliary circuits - Phase conductor marking (black) - Marking of PE, N, PEN - Compliance with clearances and creepage distances - Up to a rated insulation voltage of AC 690 V, compliance with the following clearances is recommended (especially for busbars): - bare, energized live parts to bach other: 10 mm - bare, energized live parts to bach other: 1	8.6.3 + Annex H 8.6.1 8.4. 3.2.3 8.4.3.2.3 + Table 3 8.6.1 Sections 1+2 8.6.4 + Table 4 8.6.5 8.6.6 8.3
3.4	Terminals for external conductors – The terminals shall be designed to the circuit's current load capacity and Short-circuit withstand strength. – Terminals for external protective conductors	8.8 Table A.1, Annex A
3.5	ASSEMBLY of doors, covers and of cladding - Compliance with the protection against direct contact (e.g. IP2x or IPXXB) - Observing the protective measure - Protection class I (with protective conductor) - Protection class II (double insulation) - Compliance with the IP degree of protection	8.4.2 8.4.2.3 8.4.4 8.2.2
3.6	Labels / documentation – Type plate – Distribution board data – Handling, installation, operating and maintenance instructions – Equipment markings / wiring diagrams	6.1 6.2.1 6.2.2 6.3

Data collection tables

Characteristics	Information provided by the planner / customer	Information provided by the manufacturer
Nominal voltage of the incoming	AC V Hz	U = V
supply	DC V	f_ =Hz
System	TN-C	Protection by automatic disconnection
	TN-C-S	of the power supply (PC I)
	TN-S	
	π	protection by protective insulation (PC II)
	П	
Rated current	Supply current (nominal current transformer / upstream	
	protective device)	
Short-circuit withstand strength	l = kA	I. = KA
(please see notes on pages 912)	(uninfluenced short-circuit current at the supply terminals)	
	(
Overvoltage	Overvoltage category	Rated impulse withstand voltage
-	W	U _{imp} = kV
	IV	nıµ
Incoming line connection	from below	single-core cable
	from above	multi-core cable
	copper conductor	
	aluminium conductor	mm ² section
	connection using terminal blocks	copper conductor
		aluminium conductor
		connection to equipment
		connection using terminal blocks

Consumer / circuit types	Information pr	rovided by the planner / customer	Data to be derived from step 2 by manufacturer		
	Number of circuits	Type of protective device	Distribution board ratings	Circuit ratings	Type of protective device
Distribution circuits for downstream subdistri- bution boards		Length fuse MCB MCCB			

Final circuits					
	Number of circuits	Type of the protective conductor connection	Consumer ratings	Circuit ratings	Type of protective device
Socket		fuse MCB Circuit breaker and residual current device	A	I _{nc} = A	
Ohmic load, heater		Internet fuse Internet MCB Internet MCCB Internet MCCB	KW	I _{nc} = A	
Inductive consumer, motor, direct		Length fuse Length MCB Length MCCB	kW cos <i>\$</i>	I _{nc} = A	
Inductive consumer, motor, controlled		fuse MCB manufacturer's description	kW cos <i>\$</i>	I _{nc} = A	
Capacitive consumers		fuse MCB manufacturer's description	kW cos <i>\$</i>	I _{nc} = A	

Data collection tables

Conditions of use	Information provided by the	Measures/recommendations of the AS	Selection	
	planner / customer	Definition pursuant to standard IEC 61439-1	This information is to be taken into account in designing ASSEMBLIES	
Indoor installation	Atmospheric conditions Foreign bodies / dust	not less than IP2X	Comply with more severe requirements arising from the product standard	
	Foreign bodies	Diameter ≥ 12.5 mm	IP2X	
	Foreign bodies	Diameter ≥ 2.5 mm	IP3X	
	Dust Increased presence of dust	dust-protected	IP5X	
	Dust conductive	dusttight	IP6X	
	Humidity / water			
	Dripping water		IPX1	
	Occasional cleaning around the distribution board, impact by diverted water		IPX4	
	Functional cleaning around the distribution board, impact by diverted water		IPX5	
	Temporary immersion		IPX7	
	Room air conditioned / tempera- ture range	-5 to +35 °C	Indicate the power loss of the ASSEMBLY for the dimensioning of the air-conditioning	
	Room ventilated / temperature range, relative humidity	-5 to +35 °C 90 % at 20 °C, up to 50 % at 40 °C	Indicate the power loss of the ASSEMBLY in order for venti- lation dimensioning; and state the room size. Higher ambient air temperatures are to be taken into account in the planning of ASSEMBLIES	
Outdoor installation	Protected installation / temperature range, relative humidity (against rain, sunshine and wind)	-25 to +35 °C 90 % at 20 °C, up to 50 % at 40 °C, short term up to 100 % at 25 °C	Possible measures against moderate condensation due to temperature variations: Ventilating, heating, air conditioning	
	Foreign bodies / dust	not less than IP2X	For increased dust production use a higher degree of protection such as IP5X	
	Humidity / water	not less than IPX1	The manufacturer states the suitability of the protected installation, if necessary by applying additional measures	
	Unprotected installation / temperature range rel. humidity	-25 to +35 °C 90 % at 20 °C, up to 50 % at 40 °C, short term up to 100 % at 25 °C	Higher ambient air temperatures which might result from direct sunlight are to be taken into account in the planning of ASSEMBLIES Possible measures against moderate condensation due to temperature variations: Ventilating, heating, air conditioning	
	Direct sunlight	UV resistance	Follow manufacturer's instructions	
	Foreign bodies / dust	not less than IP2X	For increased dust production use a higher degree of protection such as IP5X	
	Humidity / water	not less than IPX1	The manufacturer states the suitability of the protected installation, if necessary by applying additional measures	

Data collection tables

Conditions of use	Information provided by the	Measures/recommendations of the ASS	Selection	
	planner / customer	Definition pursuant to standard IEC 61439-1	This information is to be taken into account in the planning of ASSEMBLIES	
Dimensions for transport and installation	Type of installation: To the wall (recess), to the wall, free installation to base frame, double floor	None		
	Aisle widths / escape routes: Room dimensions and access doors	See IEC 60364-7-729 Requirements for special installations or locations – operating or maintenance gangways	Minimum aisle widths and the direction of the escape routes are to be taken into account in the planning of ASSEMBLIES	
	Distribution board: max. dimensions: W x H x D max. weight	None	Possible restrictions are to be stated	W H D kg
	Transport: max. transport dimen- sions W x H x D, max. transport weight Transport type, e.g. crane Accessibility at the construction site	None	Possible restrictions are to be stated, such as only standing transport, max. acceleration values	W H D kg
Chemical influences		None	Type of the enclosure material Chemical device version Special installation / ventilation	
Mechanical impact		Sub-distribution board Indoor installation Outdoor installation		IK05 IK07
Enclosure material	Sheet steel Plastic	None		
Enclosure colour			Comply with customer specifications / call for tender documents	
EMC	Environment A Non-public or industrial LV networks / areas / installations including strong sources of interference		Confirmation by the manufacturer in accordance with environment A	
	Environment B Public LV networks such as domestic, commercial and light industrial locations		Confirmation by the manufacturer in accordance with environment B	

Characteristics	Information provided by the planner / customer	Information provided by the manufacturer	Selection
Operation through:	Skilled person (electrically)	IPXXB	
	Instructed person	IPXXB	
		IPXXC	
Device activation	Behind the door / cover From outside		
Access / door closure	Lock For semi-cylinder (central locking system) Other		

Verification of temperature rise up to 630 A

				Rated current of the equipment I _n	P _{vn}	Derating ¹⁾	Rated current of a circuit I_{nc}	Assumed load factor ²⁾	Assumed operating current I _B	Power loss of a device at $I_{\rm B}$	Sum of the power losses		
		urer		E	(A)	(W)		(A)		(A)	(W)	(W)	
Pos	Number	Manufactu	Manufactu	Type	Descriptic						$I_{\rm B} = I_{\rm nc} \cdot$ assumed load factor	$P_{_{B}}=P_{_{V\!\Pi}}\cdot(I_{_{B}}\!/I_{_{\Pi}})^{2}$	$P_{vB} = P_B \cdot number$
Sum of the installed power losses													
										Wiring power	er loss (%) ³⁾ 30		
									Р	ower loss dissipatio	on of the enclosure		
Difference = power loss dissipation – sum of the installed power loss = $P_{vzul} - \sum P_{vB}$													

1) According to IEC 61439-2 Table 101 - Values of assumed loading - depending on the number of equipment used in the same time

2) Manufacturer information for equipment under different conditions, but not less than 0.8 in line with section 10.10.4.2.1c

3) The wiring power loss is assumed as percentage of the equipment power losses – proposal: 30 %

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